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## AMENDMENTS TO THE SPECIFICATION

Please change the title to "Method For Fabricating Hybrid Interconnect And System For Testing Semiconductor Dice".

On page 2, line 1 in the "Cross Reference To Related Applications" added by the Preliminary Amendment dated April 30, 1999, please add a patent number for the parent case.

### --Cross Reference To Related Applications

This application is a division of patent application no. 08/821,468, filed March 21, 1997, Patent No. 6,025,731.--